

F4P4532EL TYPE

●FEATURE

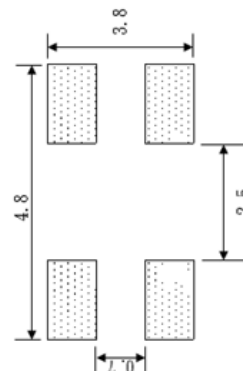
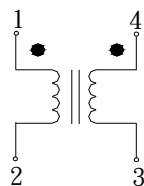
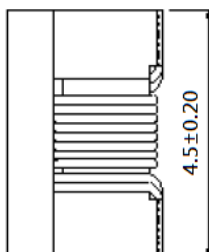
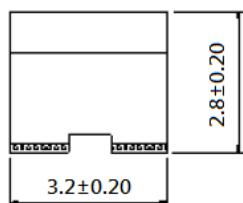
1. For automobile signal line
2. Same as TDK ACT45B type

●Applications

1. CAN-BUS, FAXs, modems, ISDNs, etc

●Shape and Dimension and Schematics and Land Patterns(mm)

F4P4532EL (1812)



●Specification

Dimension in m/m

PART NO.	Common Mode INDUCTANCE (uH) (+50%/-30%)	Rated Current (mA)	Rated Voltage (Vdc)	Insulation Resistance (M ohm)	Withstand Voltage (Vdc)	DC Resistance (max.) (ohm)
F4P4532EL-110	11uH at 100KHz	250	50	10 min	125	0.6
F4P4532EL-220	22uH at 100KHz	200	50	10 min	125	1.0
F4P4532EL-510	51uH at 100KHz	200	50	10 min	125	1.0
F4P4532EL-101	100uH at 100KHz	150	50	10 min	125	2.0

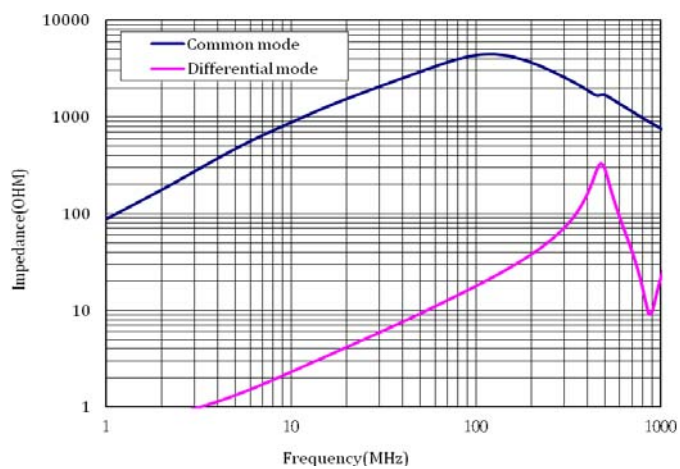
Note1. Measurement ambient temperature of electrical : at 20°C

Note2. Test equipment: HP4291A

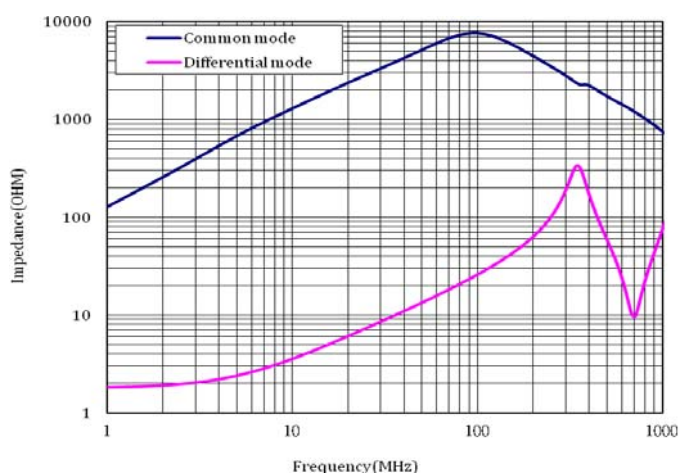
Note3. Packaging: Taping ; Quantity: 500 Pieces/reel

●F4P 4532EL(Impedance VS Frequency)

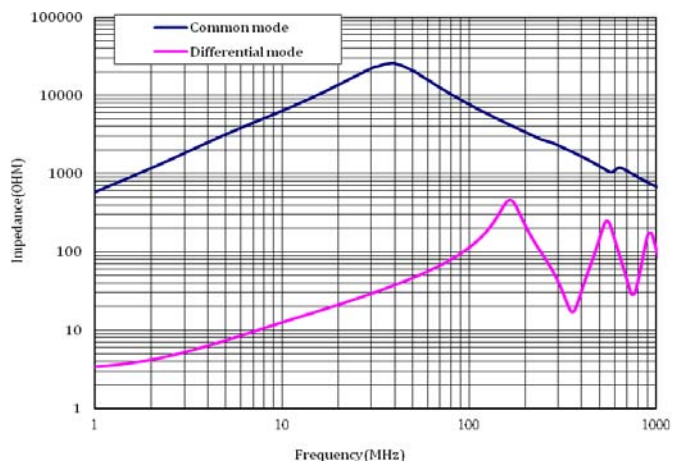
F4P4532EL-110



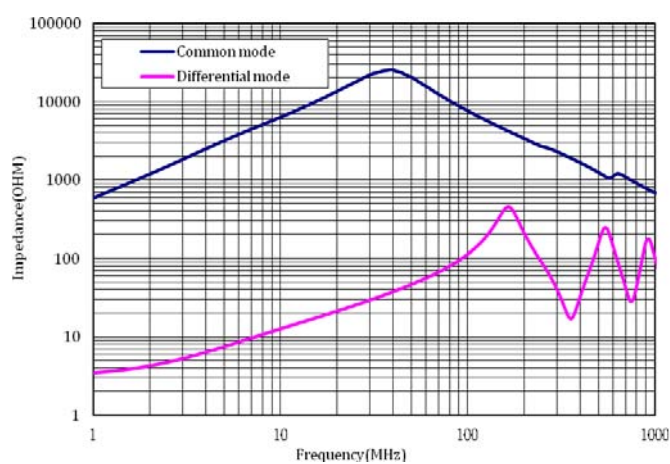
F4P4532EL-220



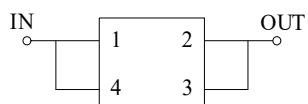
F4P4532EL-510



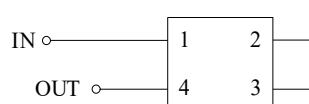
F4P4532EL-101



●Test circuit



COMMON MODE

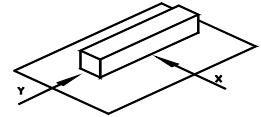


NORMAL MODE

GENERAL CHARACTERISTICS

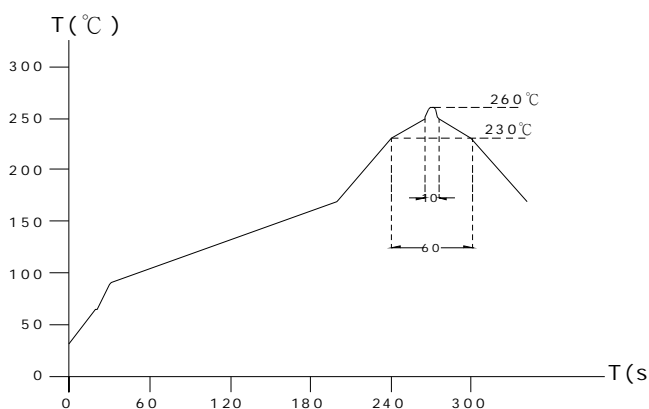
1. Operating temperature range: -40 TO $+125^{\circ}\text{C}$ (Includes temperature when the coil is heated)
2. External appearance: On visual inspection, the coil has no external defects.
3. Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Y withstanding at below conditions.

Terminal should not peel off. (refer to figure at right) 0.5kg Min –F4P4532EL.



4. Insulating resistance: Over $100\text{M}\Omega$ at 100V D.C. between coil and core.
5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
6. Temperature characteristics: Inductance coefficient $(0\sim 2,000)\times 10^{-6}/^{\circ}\text{C}$ ($-25\sim +80^{\circ}\text{C}$). , inductance deviation within $\pm 5.0\%$, after 96 hours.
7. Humidity characteristics(Moisture Resistance): Inductance deviation within $\pm 5\%$, after 96 hours in $90\sim 95\%$ relative humidity at $40 \pm 2^{\circ}\text{C}$ and 1 hour drying under normal condition.
8. Vibration resistance: Inductance deviation within $\pm 5\%$, after vibration for 1 hour. In each of three orientations at sweep vibration ($10\sim 55\sim 10\text{ Hz}$) with 1.5mm P-P amplitudes.
9. Shock resistance: Inductance deviation within $\pm 5\%$, after being dropped once with 981m/s^2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
10. Resistance to Soldering Heat: 260°C , 10 seconds(See attached recommend reflow)
11. Storage environment: Storage condition: Temperature Range: $10^{\circ}\text{C} \sim 35^{\circ}\text{C}$ (Generally: $21^{\circ}\text{C} \sim 31^{\circ}\text{C}$) , Humidity Range: $50\% \sim 80\% \text{ RH}$ (Generally: $65\% \sim 75\%$) ; Transportation condition: Temperature Range: $-35^{\circ}\text{C} \sim 85^{\circ}\text{C}$, Humidity Range: $50\% \sim 95\% \text{ RH}$
12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
13. Reflow profile recommend:

Lead-free heat endurance test



Lead-free the recommended reflow condition

